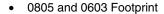
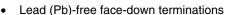
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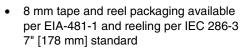


Solid Tantalum Chip Capacitors MICROTAN™ Lead Frameless Molded

FEATURES











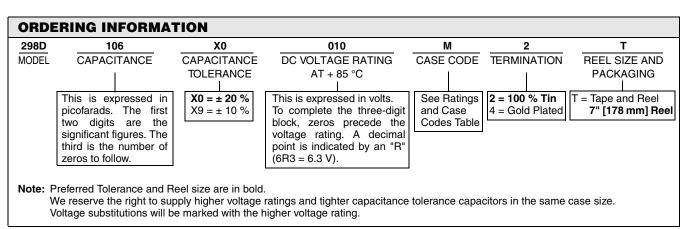


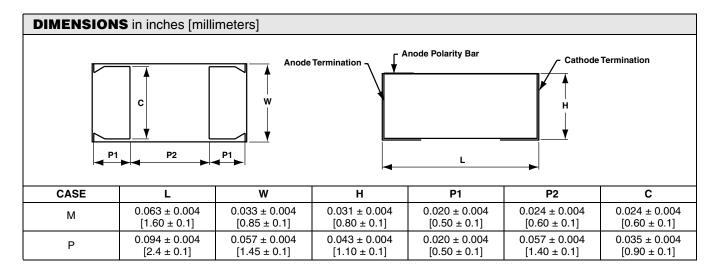
PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 85 °C

(to + 125 °C voltage derating)

Capacitance Range: 1 μ F to 220 μ F Capacitance Tolerance: \pm 20 % standard Voltage Range: 2.5 WVDC to 25 WVDC







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RATINGS AND CASE CODES						
μF	2.5 V	4 V	6.3 V	10 V	16 V	25 V
1.0					М	М
2.2			М	М	М	
3.3						
4.7			М	М	М	Р
6.8						
10		М	М	M		
15				М		
22		М	М			
33		М	М	P*		
47	М	М	P*	Р		
100	M*	P*	Р			
220	Р	Р				

Volts	Code
4	G
6.3	J
10	Α
16	С
20	D
25	Е

CAP, μF	Code
33	n
47	S
68	w
100	Ā
150	Ē
220	Ī

Note:

* Preliminary values, contact factory for availability.

STANDARI	RATI	NGS					
CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX DC LEAKAGE AT + 25 °C (μΑ)	MAX DF AT + 25 °C (%)	MAX ESR AT + 25 °C 100 kHz (Ω)	MAX RIPPLE 100 kHz I _{rms} (A)	∆C/C ⁽¹⁾ (%)
		2.5 WVDC AT + 85 °C, SI	JRGE = 3.3 V	. 1.6 WVDC AT	+ 125 °C, SURGE	= 2.1 V	
47	М	298D476X02R5M2T	2.4	20	4.0	0.08	± 30
100	М	298D107X02R5M2T	25.0	40	2.5	0.100	± 30
220	Р	298D227X02R5P2T	11.0	30	3.0	0.122	± 30
		4 WVDC AT + 85 °C, SU	RGE = 5.2 V	2.7 WVDC AT +	125 °C, SURGE	= 3.4 V	
10	М	298D106X0004M2T	0.5	8.0	3.0	0.09	± 10
22	М	298D226X0004M2T	0.9	15	4.0	0.08	± 15
33	M	298D336X0004M2T	2.6	15	4.0	0.08	± 20
47	М	298D476X0004M2T	3.8	20	4.0	0.08	± 30
100	Р	298D107X0004P2T	4.0	20	2.0	0.1	± 30
220	Р	298D227X0004P2T	17.6	30	3.0	0.122	± 30
		6.3 WVDC AT + 85 °C,	SURGE = 8 V	. 4 WVDC AT +	125 °C, SURGE	= 5 V	
2.2	М	298D225X06R3M2T	0.5	10	5.0	0.07	± 10
4.7	М	298D475X06R3M2T	0.5	8.0	3.0	0.09	± 10
10	М	298D106X06R3M2T	0.6	8.0	3.0	0.09	± 10
22	М	298D226X06R3M2T	2.8	15	4.0	0.08	± 15
33	М	298D336X06R3M2T	4.2	20	4.0	0.08	± 30
47	Р	298D476X06R3P2T	3.0	22	3.0	0.122	± 20
100	Р	298D107X06R3P2T	6.3	30	2.0	0.150	± 20
		10 WVDC AT + 85 °C,	SURGE = 13 V.	7 WVDC AT +	- 125 °C, SURGE	= 8 V	
2.2	М	298D225X0010M2T	0.5	10	10	0.05	± 10
4.7	М	298D475X0010M2T	0.5	6.0	4.0	0.08	± 15
10	М	298D106X0010M2T	1.0	8.0	4.0	0.08	± 15
15	М	298D156X0010M2T	1.5	12	4.0	0.08	± 20
33	Р	298D336X0010P2T	3.3	10	2.0	0.150	± 10
47	Р	298D476X0010P2T	4.7	22	3.0	0.122	± 20
		16 WVDC AT + 85 °C, S	URGE = 20 V	. 10 WVDC AT +	- 125 °C, SURGE	= 12 V	
1.0	М	298D105X0016M2T	0.5	6.0	12.0	0.045	± 15
2.2	М	298D225X0016M2T	0.5	10	12.0	0.045	± 15
4.7	М	298D475X0016M2T	0.8	8.0	6.0	0.06	± 15
		25 WVDC AT + 85 °C, S	URGE = 32 V	. 17 WVDC AT +	- 125 °C, SURGE	= 20 V	
1.0	М	298D105X0025M2T	0.5	6.0	10.0	0.05	± 10
4.7	Р	298D475X0025P2T	1.2	6.0	4.0	0.106	± 10

Note

(1) See Performance Characteristics tables, page 41.

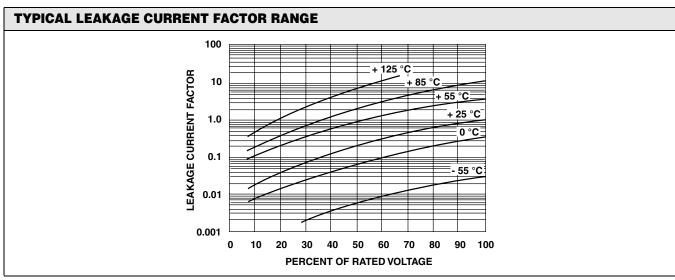
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CAPACITORS PERFORMANCE CHARACTERISTICS

ITEM	PERFORMANCE CHARACTERISTICS				
Category Temperature Range	- 55 °C to + 85 °C (to + 125 °C with voltage derating)				
Capacitance Tolerance	± 20 %, ± 10 % (at 120 Hz) 2 V _{rms} at + 25 °C using a	capacitance bridge		
Dissipation Factor (at 120 Hz)	Limits per Standard Rating	s Table. Tested via bridge n	nethod, at 25 °C, 120 Hz.		
ESR (100 kHz)	Limits per Standard Rating	s Table. Tested via bridge n	nethod, at 25 °C, 100 kHz.		
Leakage Current	After application of rated voltage applied to capacitors for 5 minutes using a steady source of power with 1 $k\Omega$ resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in. See graph below for the appropriate adjustment factor.				
Reverse Voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC 5 % of the DC rating at + 85 °C Vishay does not recommended intentional or repetitive application of reverse voltage				
Temperature Derating	If capacitors are to be used at temperatures above + 25 °C, the permissible rms ripple current or voltage 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C				
Maximum Permissible Power Dissipation at 25 °C (W) in free air	M-case: 0.025 P-case: 0.045				
Operating Temperature	+ 85 °C		+ 125 °C RATING		
	WORKING VOLTAGE	SURGE VOLTAGE	WORKING VOLTAGE	SURGE VOLTAGE	
				SURGE VOLIAGE	
	4	5.2	2.7	3.4	
	4 6.3	8	4	3.4 5	
		-	+	3.4 5 8	
	6.3 10 16	8 13 20	4	3.4 5 8 12	
	6.3 10	8 13	4 7	3.4 5 8	
	6.3 10 16 20 25	8 13 20 26 32	4 7 10 13 17	3.4 5 8 12 16 20	
	6.3 10 16 20	8 13 20 26	4 7 10 13	3.4 5 8 12 16	



Notes

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings Table
- \bullet At + 85 $^{\circ}$ C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings Table
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings Table

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For technical questions, contact: tantalum@vishay.com

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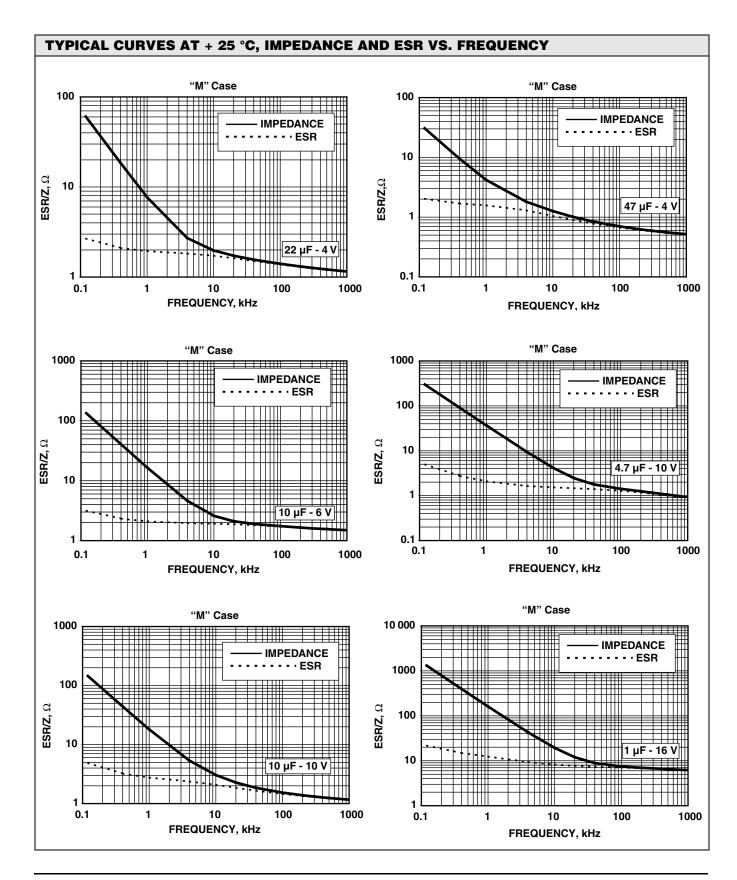


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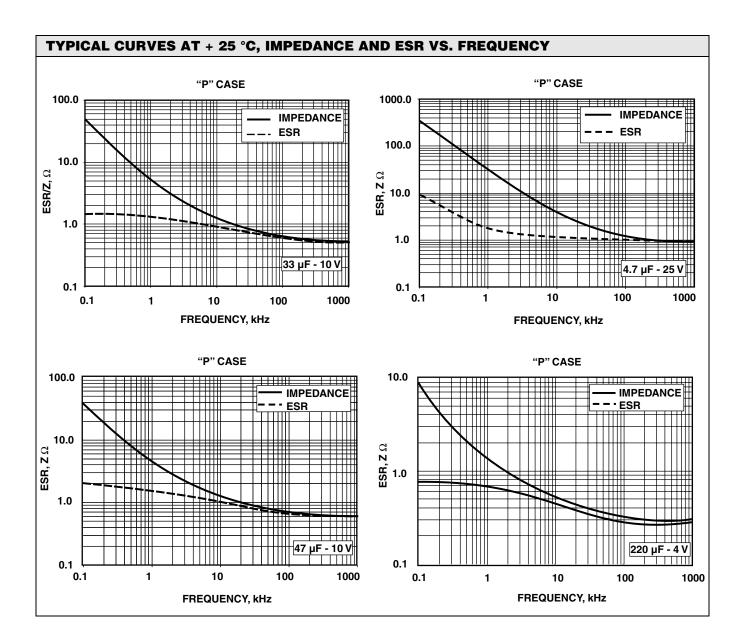
ENVIRONMENTAL PERFORMANCE CHARACTERISTICS					
ITEM CONDITION		POST TEST PERFOR	POST TEST PERFORMANCE		
Life Test at + 85 °C	1000 h application of rated voltage at 85 °C with a 3 Ω series resistance, MIL-STD 202G Method 108A	Capacitance Change Dissipation Factor Leakage Current	Refer to Standard Ratings Table Not to exceed 150 % of initial Not to exceed 200 % of initial		
Humidity Tests	At 40 °C/90 % RH 500 h, no voltage applied. MIL-STD 202G Method 103B	Capacitance Change Dissipation Factor Leakage Current	Refer to Standard Ratings Table Not to exceed 150 % of initial Not to exceed 200 % of initial		
Thermal Shock	At - 55 °C/+ 125 °C, 30 min. each, for 5 cycles. MIL-STD 202G Method 107G	Capacitance Change Dissipation Factor Leakage Current	Refer to Standard Ratings Table Not to exceed 150 % of initial Not to exceed 200 % of initial		

MECHANICAL PERFORMANCE CHARACTERISTICS				
TEST CONDITION	CONDITION	POST TEST PERFORMANCE		
Terminal Strength	Apply a pressure load of 5 N for 10 ± 1 s horizontally to the center of capacitor side body. AECQ-200 rev. C Method 006	Capacitance Change Refer to Standard Ratings Table Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Substrate Bending (Board flex)	With parts soldered onto substrate test board, apply force to the test board for a deflection of 1 mm. AECQ-200 rev. C Method 005	Capacitance Change Refer to Standard Ratings Table Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less		
Vibration	MIL-STD-202G, Method 204D, 10 Hz to 2000 Hz, 20 G Peak	Capacitance Change Refer to Standard Ratings Table Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Shock	Mil-Std-202G, Method 213B, Condition I, 100G Peak	Capacitance Change Refer to Standard Ratings Table Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Resistance to Solder Heat	At 260 °C, for 10 seconds, reflow	Capacitance Change Refer to Standard Ratings Table Dissipation Factor Not to exceed 150 % of initial Leakage Current Not to exceed 200 % of initial		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Solderability	MIL-STD-202G, Method 208H, ANSI/J-Std-002, Test B. Applies only to Solder and tin plated terminations. Does not apply to gold terminations.	There shall be no mechanical or visual damage to capacitors post-conditioning.		
Resistance to Solvents	MIL-STD-202, Method 215D	There shall be no mechanical or visual damage to capacitors post-conditioning.		
Flammability	Encapsulation materials meet UL94 VO with an oxygen index of 32 %.			









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